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# RENESAS SEMICONDUCTOR RELIABILITY REPORT

GROUP: RA6M2

DEVICE : R7FA6M2XXX

APPLICATION: Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



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## Table. Reliability test results (QFP)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	D22-A101 Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs 0/22		
Temperature Cycling (TC) (*1)			0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

Basically qualification tests were performed using a representative product with the same wafer process and the same package structure .

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3
•It is tested to confirm that all the samples are satisfied with an individual product specification.



## Table. Reliability test results (LGA)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	101 Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs 0/22		
Temperature Cycling (TC) (*1)	JESD22-A104	.04 Ta=-55 ℃ to 125 ℃ , 500 cycles 0/22		
Latch-Up (LU)	JESD78 Pulse Current Injection, I=+/-150 mA		0/3	
Electrostatic discharge (ESD-HBM)	JS-001	1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

<sup>\*1)</sup> With preconditioning per JESD22-A113, MSL 3

#### Note :

 $Basically\ qualification\ tests\ were\ performed\ using\ a\ representative\ product\ with\ the\ same\ wafer\ process\ and\ the\ same\ package\ structure\ .$ 

<sup>•</sup>It is tested to confirm that all the samples are satisfied with an individual product specification.

The failure rate of the device in an actual use condition can be estimated by the below procedure.

## •Equation for the failure rate estimation ( $\lambda$ )

$$\lambda = \lambda b \times \pi T$$
 (FIT)

①Unique failure rate (λb)

$$\lambda b = 0.08 \text{ FIT}$$

Unique failure rate at Ta=55 ℃ using 60 % confidence level.

②Temperature term ( $\pi$ T)

$$\pi T = \exp\{11600 \times Ea \times (1/(273+55)-1/(273+Ta))\}$$

Ea: Activation energy (eV) Ta: Ambient temperature ( $^{\circ}$ C)

$\pi$ T simplified chart as Ea=0.7 eV												
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πТ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

## ·MTTF ( Mean Time To Failure )

$$MTTF = 1/\lambda$$



## Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

<sup>\*1.</sup> First four digit

### Table. Product list

	e. Product				_		
No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RA6M2	R7FA6M2AD3CFB	PLQP0144K*	51			
2	RA6M2	R7FA6M2AF3CFB	PLQP0144K*	52			
3	RA6M2	R7FA6M2AD3CFP	PLQP0100K*	53			
4	RA6M2	R7FA6M2AF3CFP	PLQP0100K*	54			
5	RA6M2	R7FA6M2AD2CLK	PTLG0145K*	55			
6	RA6M2	R7FA6M2AD3CLK	PTLG0145K*	56			
7	RA6M2	R7FA6M2AF2CLK	PTLG0145K*	57			
8	RA6M2	R7FA6M2AF3CLK	PTLG0145K*	58			
9				59			
10				60			
11				61			
12				62			
13				63			
14				64			
15				65			
16				66			
17				67	1		1
18	1			68	1		+
19				69			
20				70			
21				71		+	
22				72	+		
23				73			
24				74			
25				75			
26				76			
27				77			
28				78			
29				79	-		
30				80			
31				81			
32				82			
33				83			
34				84			
35				85			
36				86	1		
37				87			
38				88			
39				89			
40				90			
41				91			
42				92			
43				93			
44				94			
45				95			
46				96			
47				97			
48		1		98	1		
49		<del> </del>		99	1		
50		1		100	+		+
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